

# Impact of high photon densities on AGIPD requirements

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new  
data



Universität Hamburg



# Instantaneous local heating

Basic estimation of local temperature increase due to photon absorption, neglecting heat conductance

$$\Delta T = \frac{N_{\gamma} E_{\gamma}}{V \rho c_{Si}} = \frac{2.5 mK}{10^6 \cdot 12 keV \cdot \gamma}$$

To reach melting temperature  
>  $5 \cdot 10^{11}$  photons are needed

$$E_{\gamma} = 12 keV$$

$$V = 40 \times 40 \times 300 \mu m^3$$

$$\rho = 2.33 \frac{g}{cm^3}$$

$$c_{Si} = 0.7 \frac{J}{gK}$$

# Total heat load

Heat sources:

photon absorption, photocurrent, leakage current

$$P_{\gamma abs, bunchtrain} = N_{\gamma} E_{\gamma} f = \frac{9.6W}{10^9 \cdot 12 \text{ keV} \cdot \gamma} N_{\gamma}$$

$$P_{photo, bunchtrain} = UI = U \frac{dQ}{dt} = U \frac{e N_{\gamma} E_{\gamma} f \cdot t_{drift}}{3.6eV \cdot T_{rep}}$$

$$= U \frac{e N_{\gamma} E_{\gamma} f^2 d}{3.6eV \cdot v_{drift}} = U \frac{67mW}{10^9 \cdot 12 \text{ keV} \cdot \gamma} N_{\gamma}$$

$$P_{leak} = UI_{leak} \Rightarrow$$

$$\bar{P}_{total} < \frac{1W}{10^9 \cdot 12 \text{ keV} \cdot \gamma} N_{\gamma} + UI_{leak}$$



$$\Delta T_{bunchtrain} (1 \text{ Mpix}, 1000V, 10^9 \gamma) = 2 \text{ mK}$$

$$f = 5 \text{ Mhz}$$

$$v_{drift, sat} = 1 \times 10^5 \text{ m/s}$$

$$\bar{P} = P_{bunchtrain} t_{bunchtrain} f_{XFEL}$$

$$\bar{P} = 6 \times 10^{-3} P_{bunchtrain}$$

# Local temperature increase

Estimation of local temperature increase during bunch train assuming  $10^6$  photons in a single pixel for all 3000 frames and neighboring pixels at constant temperature (heat conductance only, no additional cooling)

$$P_{10^6 \gamma, total} \leq 80 mW$$

$$\dot{Q}_{total} = \left(4 \frac{200 \times 500}{200}\right) \mu m * \lambda \Delta T$$

$$P_{\gamma, bunchtrain} = \dot{Q}$$

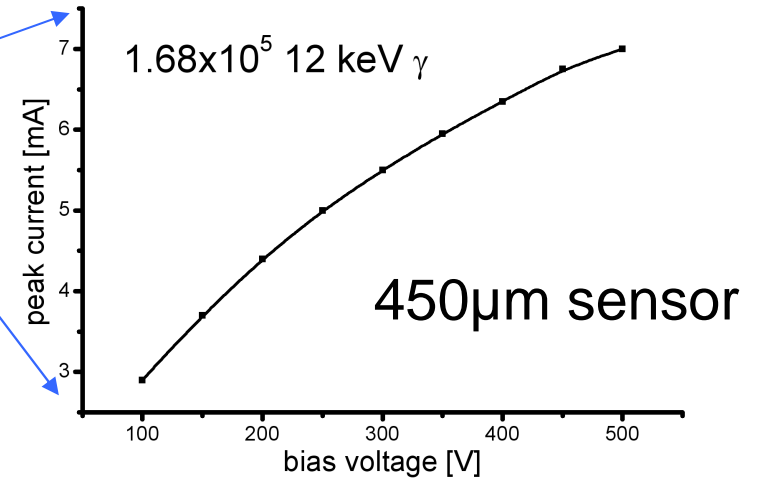
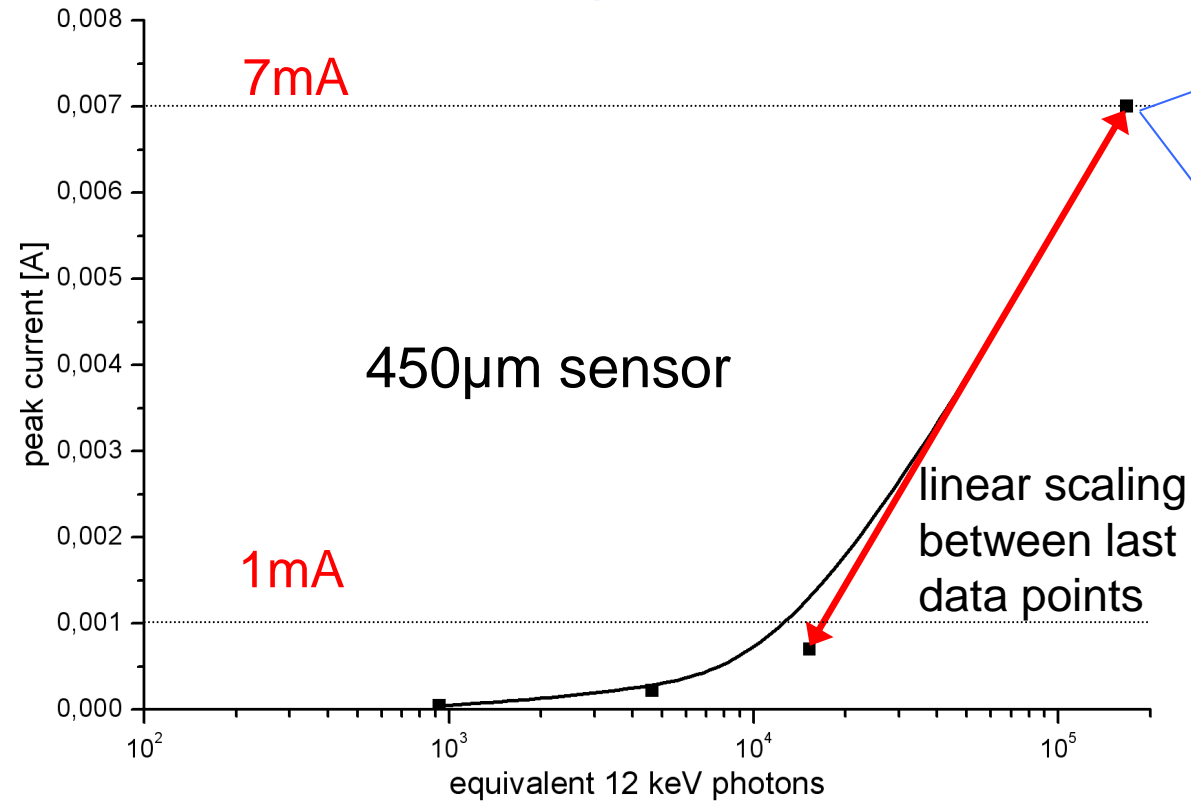
$$\Rightarrow \Delta T \leq \frac{0.27 K}{10^6 \cdot 12 keV \cdot \gamma} N_{\gamma}$$

$$\lambda_{Si} = 148 \text{ W/m} * K$$

$$\dot{Q}_{neighbor} = \lambda \frac{A}{l} \Delta T$$

$$\dot{Q}_{total} = 4 \dot{Q}_{neighbor}$$

# Confined breakdown



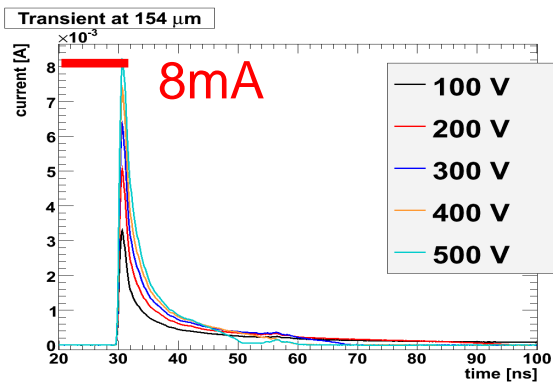
Current peaks of up to 8mA have been observed in measurements so far, assuming linear scaling to  $10^6$  and  $50 \Omega$  impedance of the preamplifier

$\Rightarrow$  4V across the input of preamp

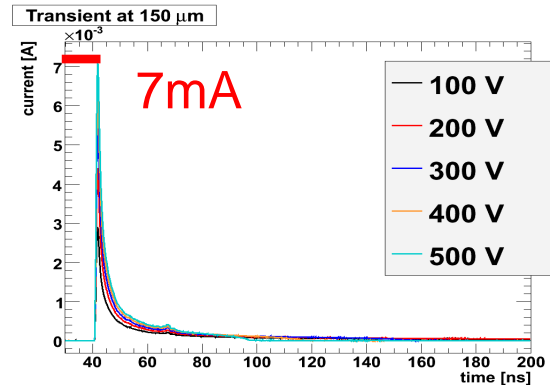
$\Rightarrow$  “killing” threshold will probably be in the region  $10^7$ - $10^8$  photons/pixel

Input protection will add noise to the measurements

Discussion of trade off between noise and dead pixel count should be encouraged



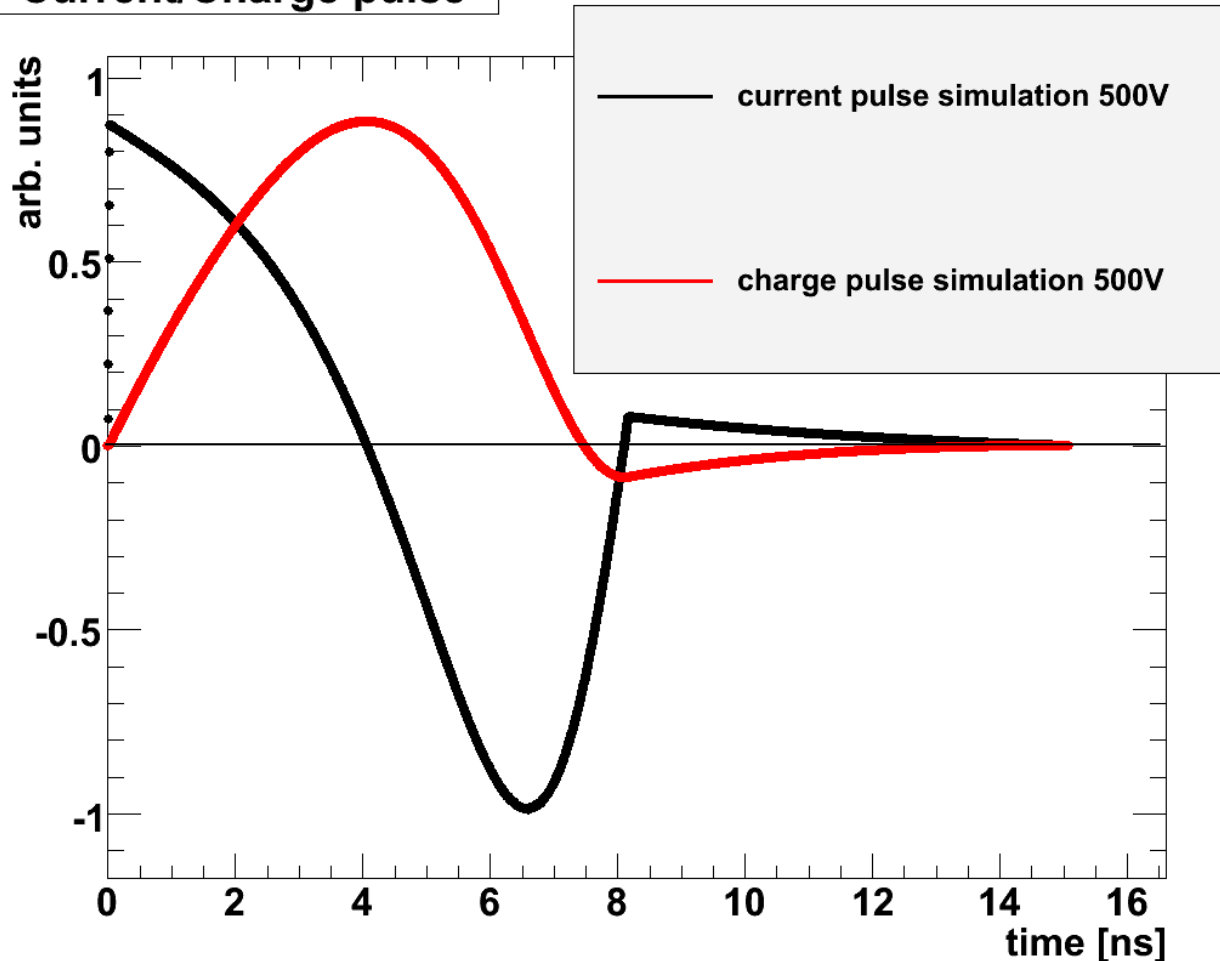
280µm sensor



450µm sensor

# Range switching in adjacent pixels

Current/Charge pulse



Current/charge pulse on adjacent pixel assuming continuous photon absorption, n-in-n pixels, no plasma effects and 500V bias.

Range switching will be triggered if peak of red curve > 85 photons.

⇒  $N_\gamma > 2600$  in primary pixel will trigger switching to second gain stage in adjacent pixels

⇒  $N_\gamma > 6.8 \times 10^4$  in primary pixel will trigger switching to third gain stage in adjacent pixels

Having a primary pixel in third gain stage will result in switching in adjacent pixels even if less than 85 photons are absorbed

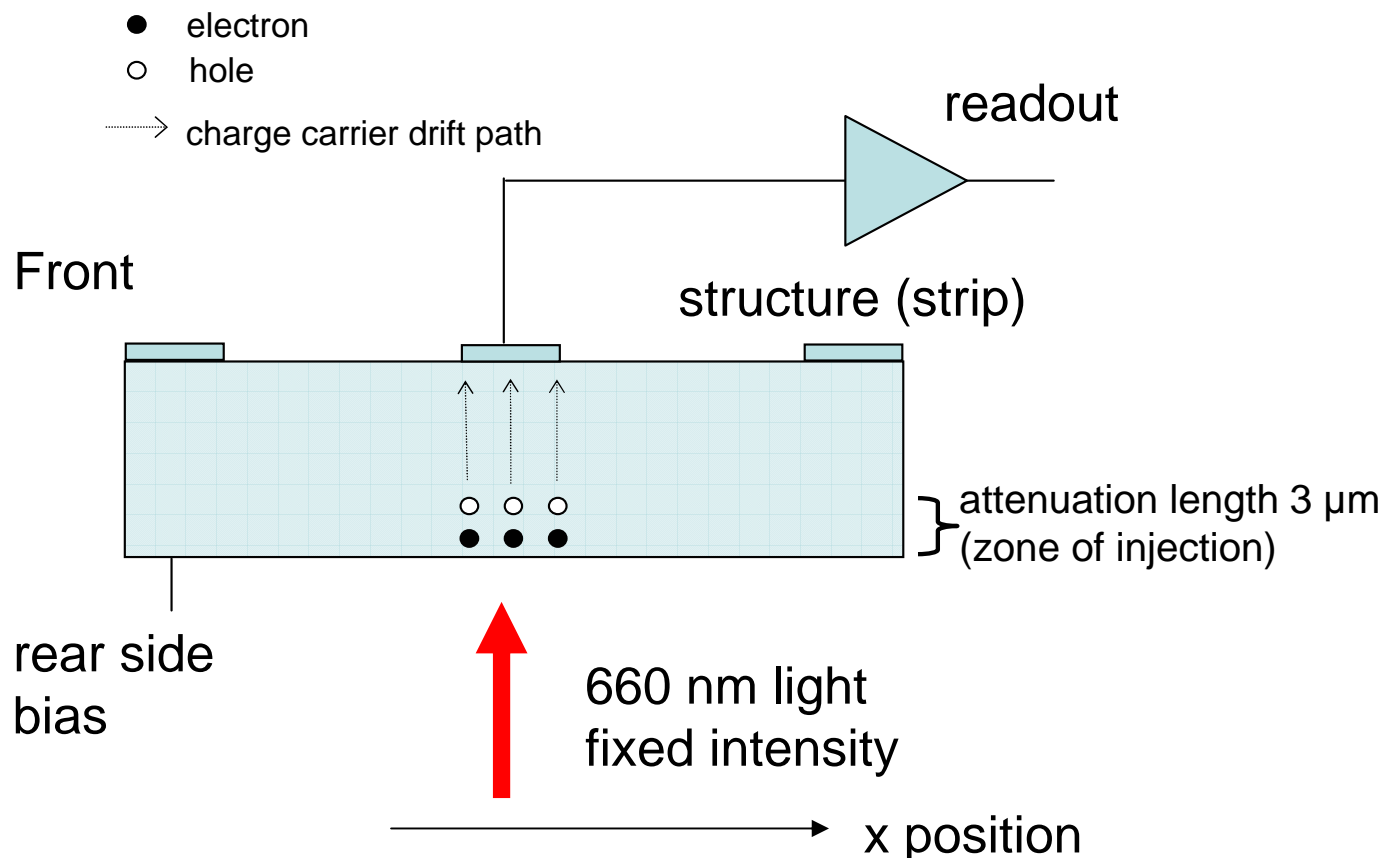
# Range switching in adjacent pixels

sensor thickness	voltage	$N_\gamma$ in primary pixel to switch to 2nd stage	$N_\gamma$ in primary pixel to switch to 3rd stage
500 $\mu\text{m}$	500V	2615	$6.77 \times 10^4$
500 $\mu\text{m}$	1000V	2880	$7.45 \times 10^4$
1000 $\mu\text{m}$	500V	2225	$5.76 \times 10^4$
1000 $\mu\text{m}$	1000V	2414	$6.25 \times 10^4$

Having a primary pixel in third gain stage will result in switching in adjacent pixels even if less than 85 photons are absorbed

# Measurements on PSI strip sensor

- injection of 660 nm and 1015 nm light from rear side
- pn junction on front side (low field at injection side)
- position scan with spotsize  $\sim 3 \mu\text{m}$



## PSI strip sensor

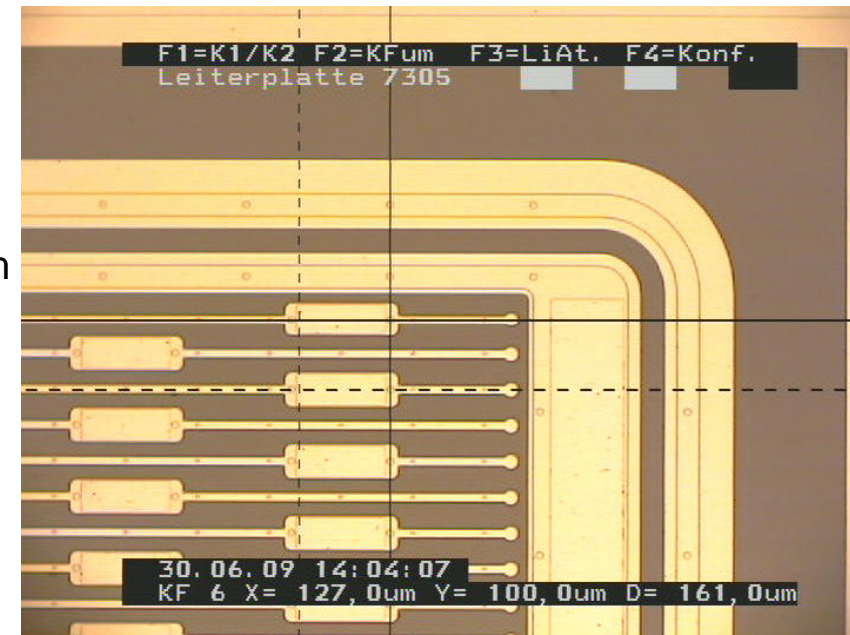
$\langle 111 \rangle$  orientation

thickness  $450 \mu\text{m}$

$U_{\text{dep}} \sim 150 \text{ V}$

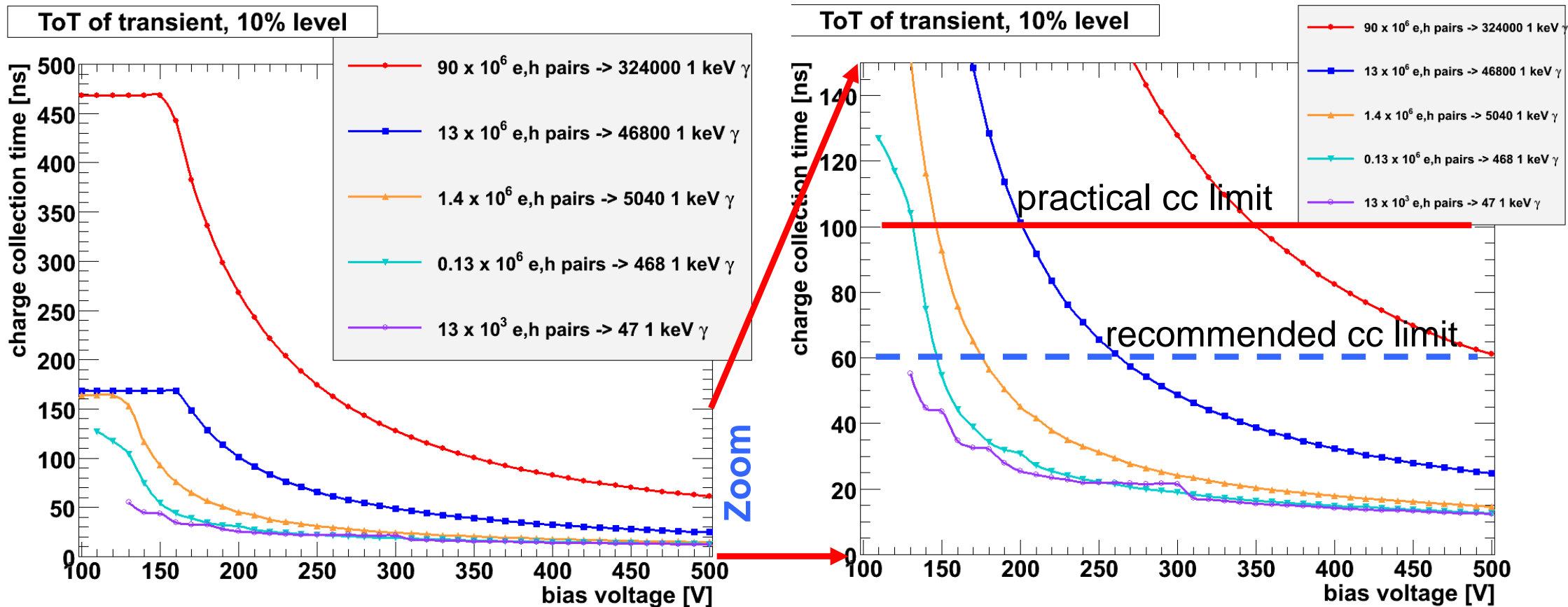
pitch  $50 \mu\text{m}$

width  $11 \mu\text{m}$





# Measurements on charge collection time



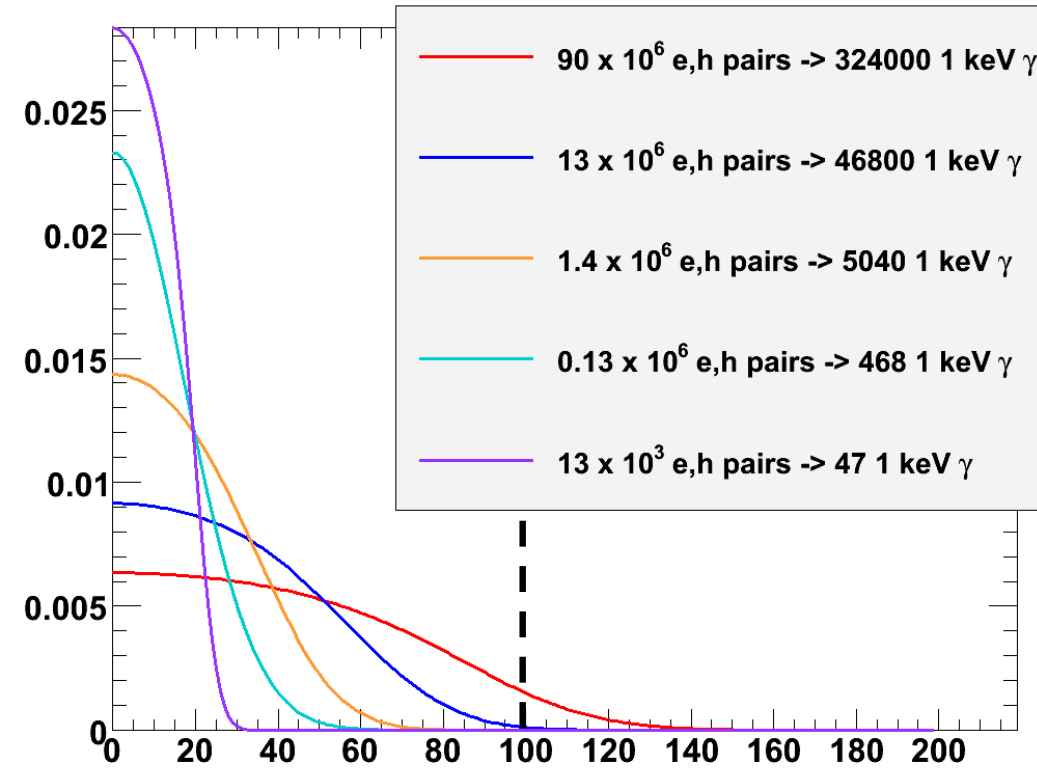
tightly focused ( $3 \mu\text{m}$ ) soft x-rays ( $\sim 1$  keV) on  $450 \mu\text{m}$  p-in-n strip sensor

plasma delays for low bias voltages included

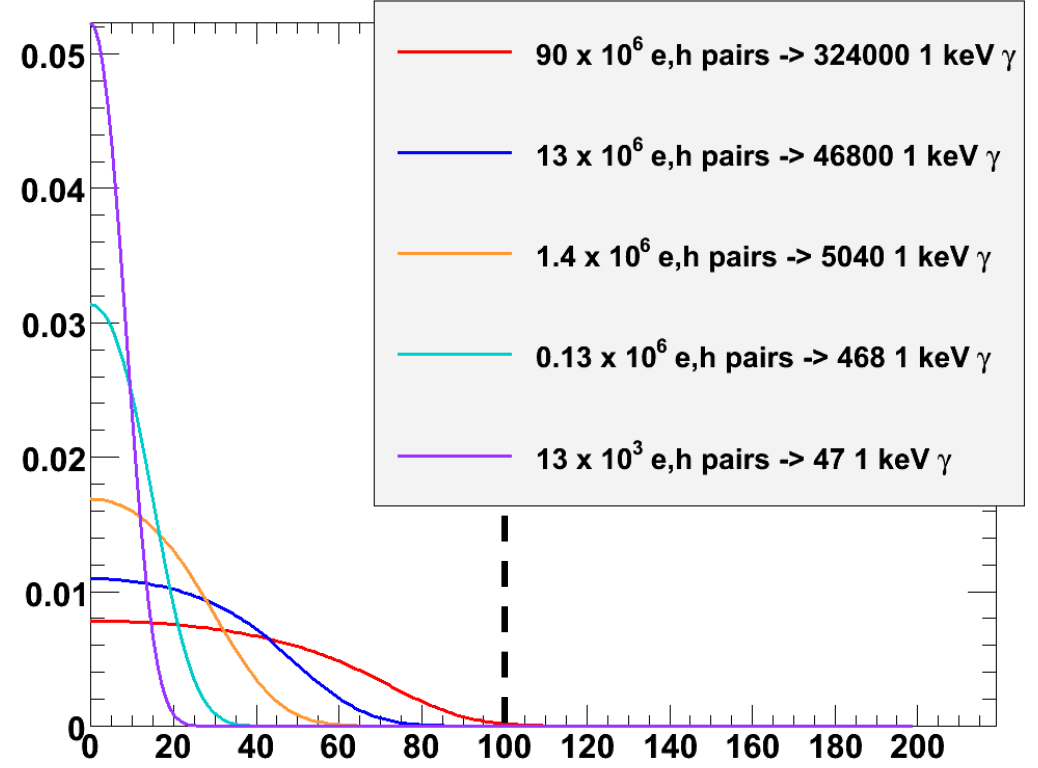
**=> charge collection time stays below 60 ns even for very high  $N_\gamma$  if sufficient voltage is applied**

# Measurements of the PSF

normalized PSF at 200V



normalized PSF at 500V



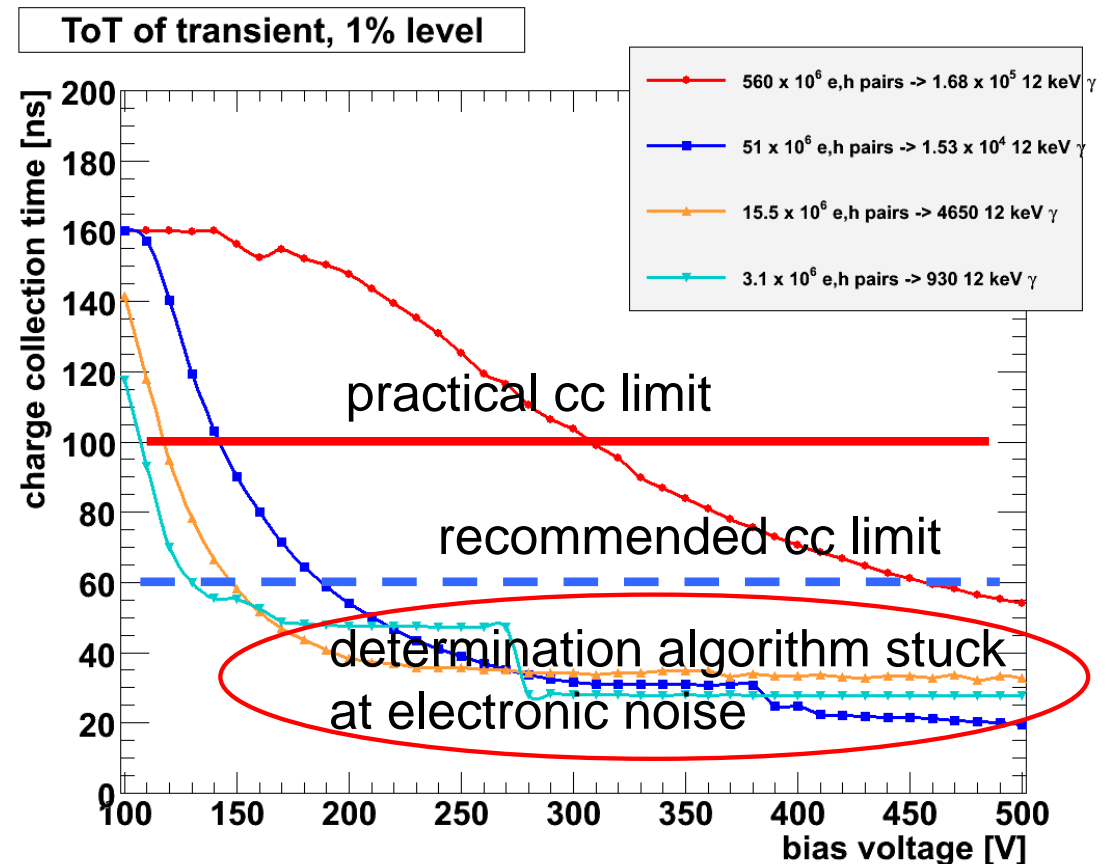
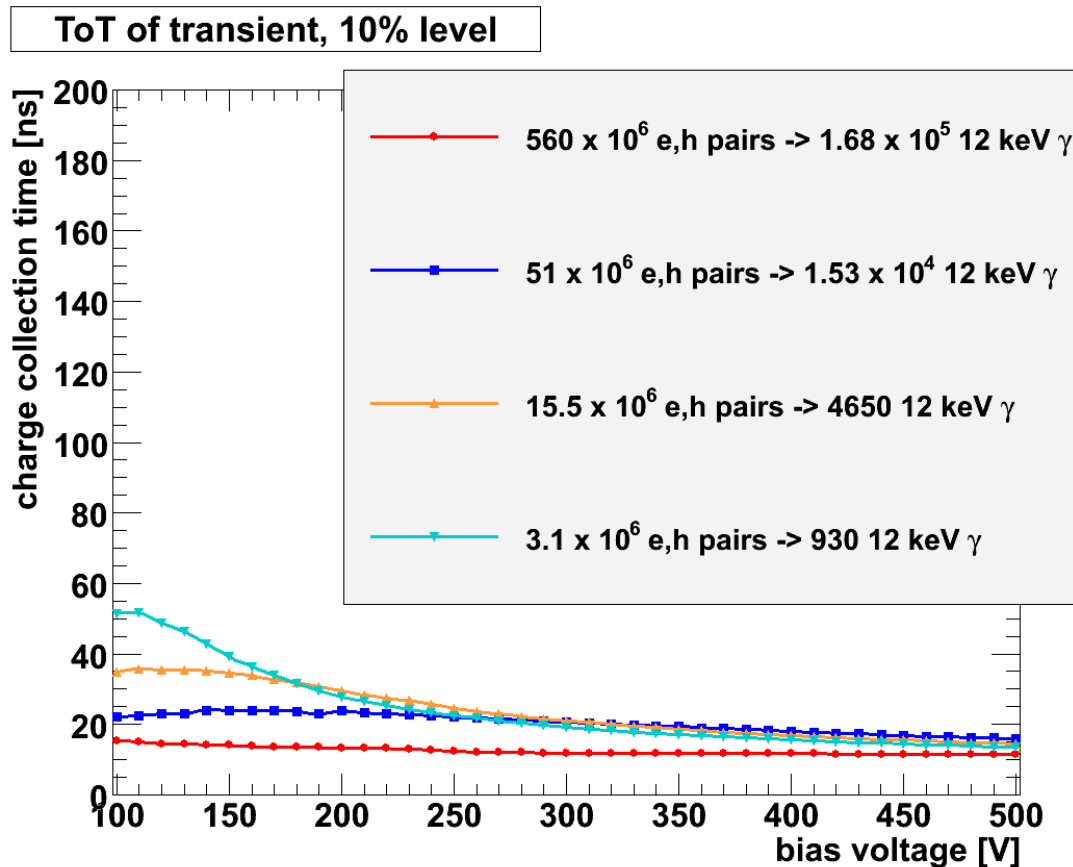
tightly focused ( $3 \mu\text{m}$ ) soft x-rays ( $\sim 1 \text{ keV}$ )

new parameterization:

Gaussian (diffusion)  $\otimes$  circle (plasma)

**=> only of minor influence on imaging performance as plasma effects stay mostly confined in the pixels**

# Measurements on charge collection time



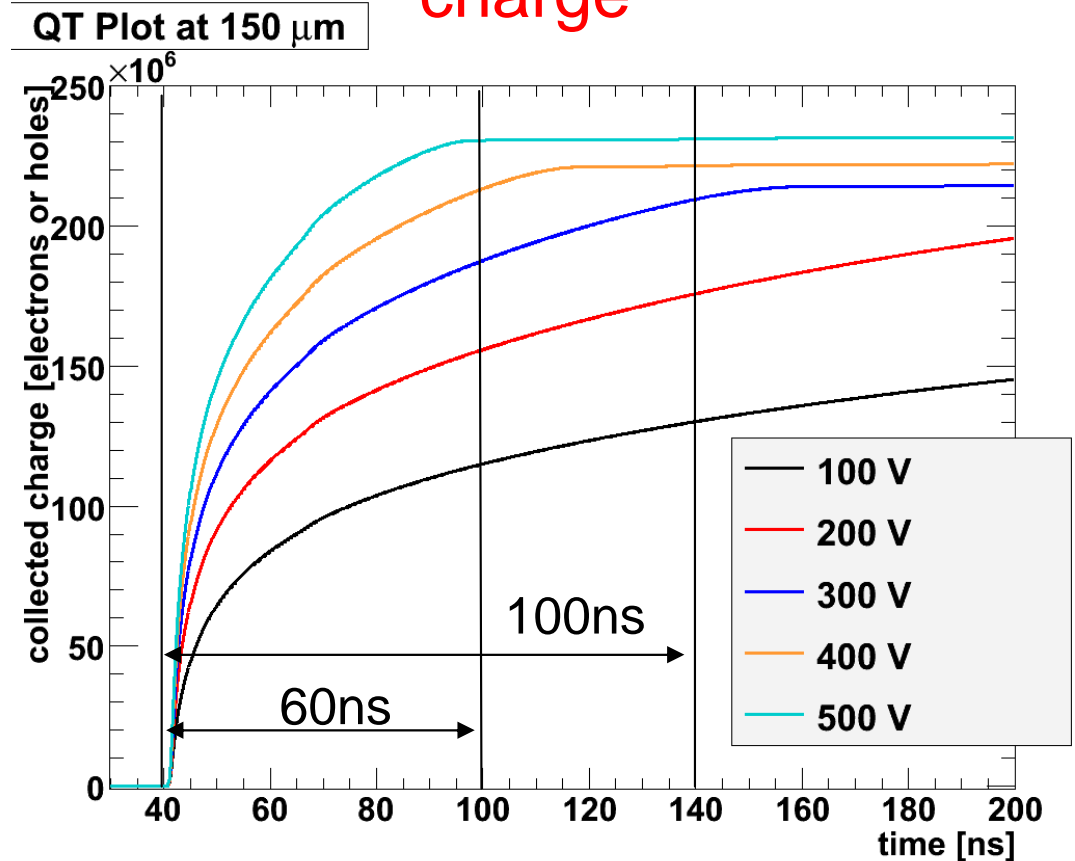
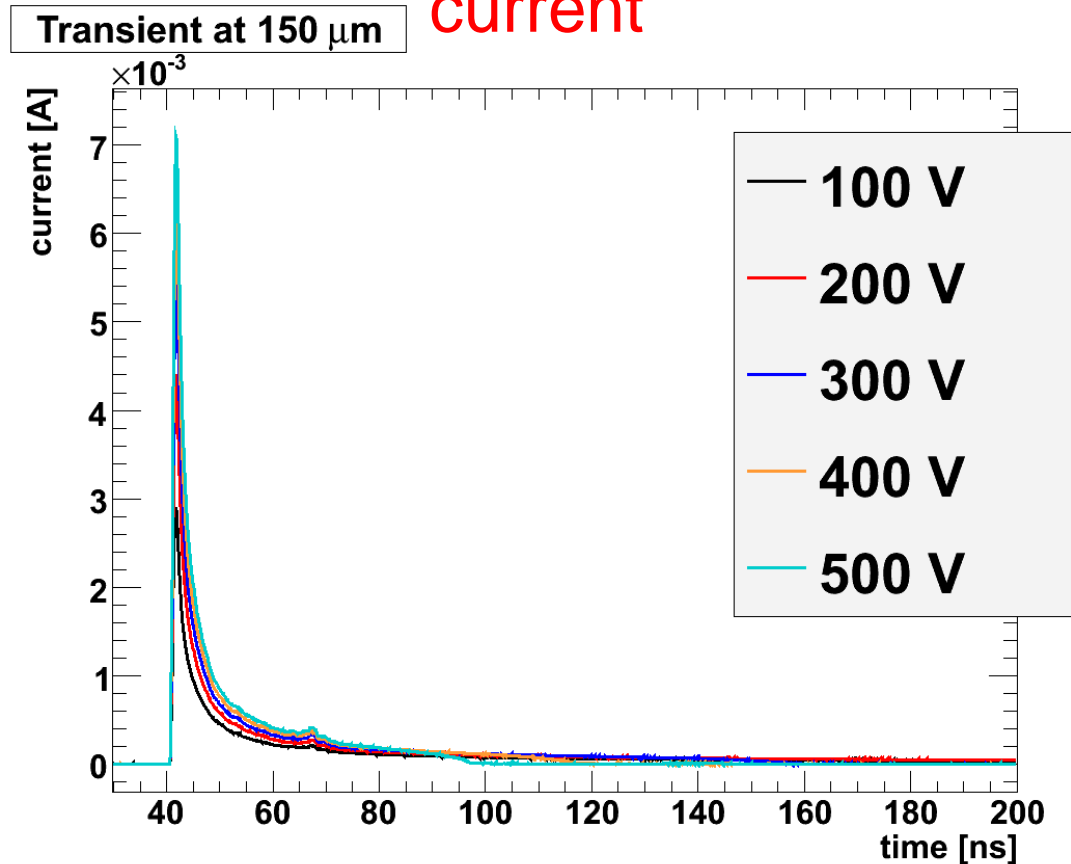
tightly focused (3  $\mu$ m), hard x-rays ( $\sim$ 12 keV) on 450  $\mu$ m p-in-n sensor  
strongly dependent on threshold level (exponential pulse shape!)

# Measurements on charge collection time

1.68 x 10<sup>5</sup> 12 keV photons

current

charge

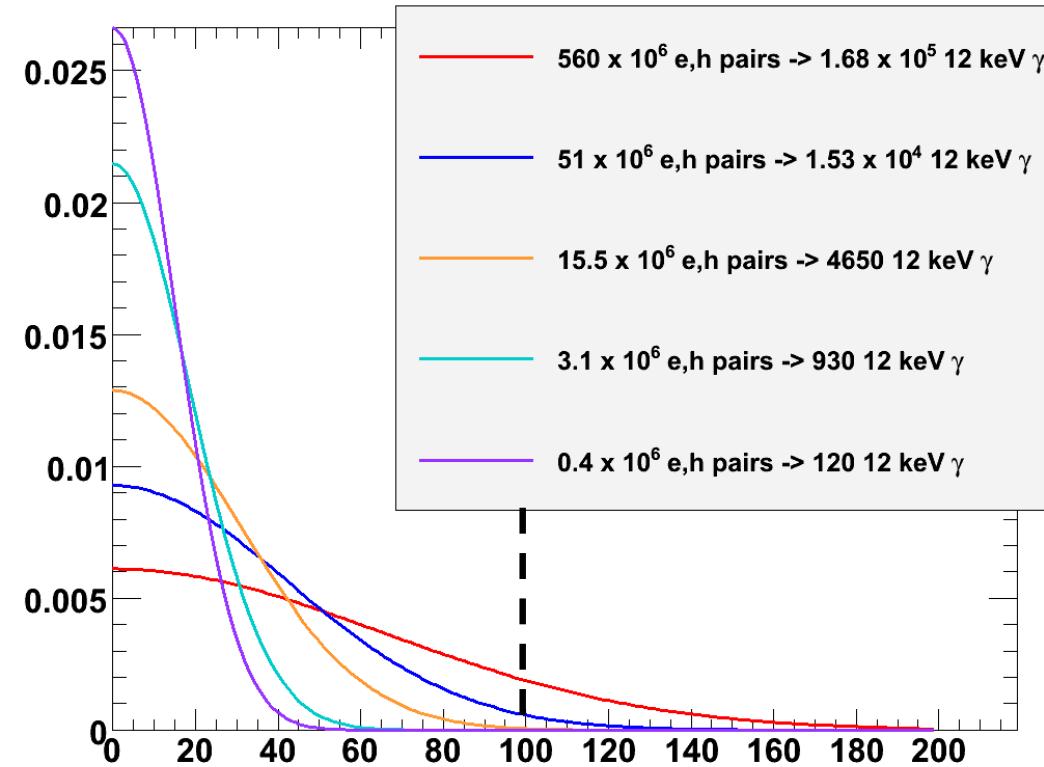


long tails may be an issue, peak increasing with voltage

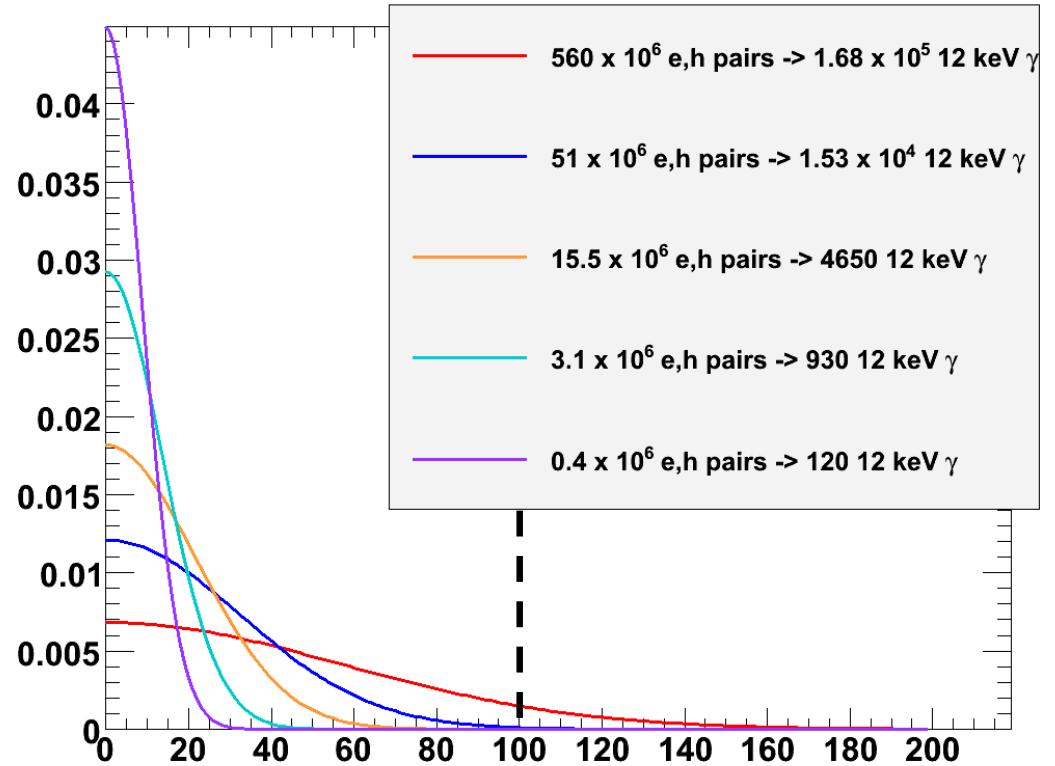
- no significant effects on current frame
- tail may spill over to next frame (0.1% of 10<sup>5</sup> photons is still 100 photons!)

# Measurements of the PSF

normalized PSF at 200V



normalized PSF at 500V



tightly focused ( $3 \mu\text{m}$ ) hard x-rays ( $\sim 12 \text{ keV}$ )

new parameterization:

Gaussian (diffusion)  $\otimes$  circle (plasma)

$\Rightarrow$  only of minor influence on imaging performance up to  $1 \times 10^4$  photons as plasma effects stay mostly confined in the pixels

# Baseline sensor specification

## Choice of technology

- n-in-n
  - superior performance in high density case
  - edges on ground

## Choice of bias voltage

- reasonably high (500 V? depends on resistivity, i.e,  $U_{dep}$ )
  - less cumbersome than 1000 V (wire bonds etc.)
  - charge collection time can be “tuned” to ASIC needs
  - less peak voltage for the ASIC to stand

## Choice of temperature

- low (-20°C?)
  - faster charge collection time (-13% for 20°C to -20°C)
  - about 5% increase in spread for high voltages (20°C to -20°C)

input from  
mechanical design  
welcome

input from  
ASIC  
designers  
welcome

# Summary

- Heating (local, global) not a problem if leakage current is low
- Pixel “killing” threshold probably around  $10^7$ - $10^8$  photons/pixel
  - Additional input protection needed?
- Range switching will occur in adjacent pixels if primary pixel is in third gain stage
- Bright pixels have long tails (no problem for soft x-rays)
  - Memory effects
  - Effective non-linearity

} under investigation next
- 500 V seems sufficient bias (even in p-in-n!) to prohibit plasma effects from deterioration the imaging performance

# Backup



# Measurements on charge collection time

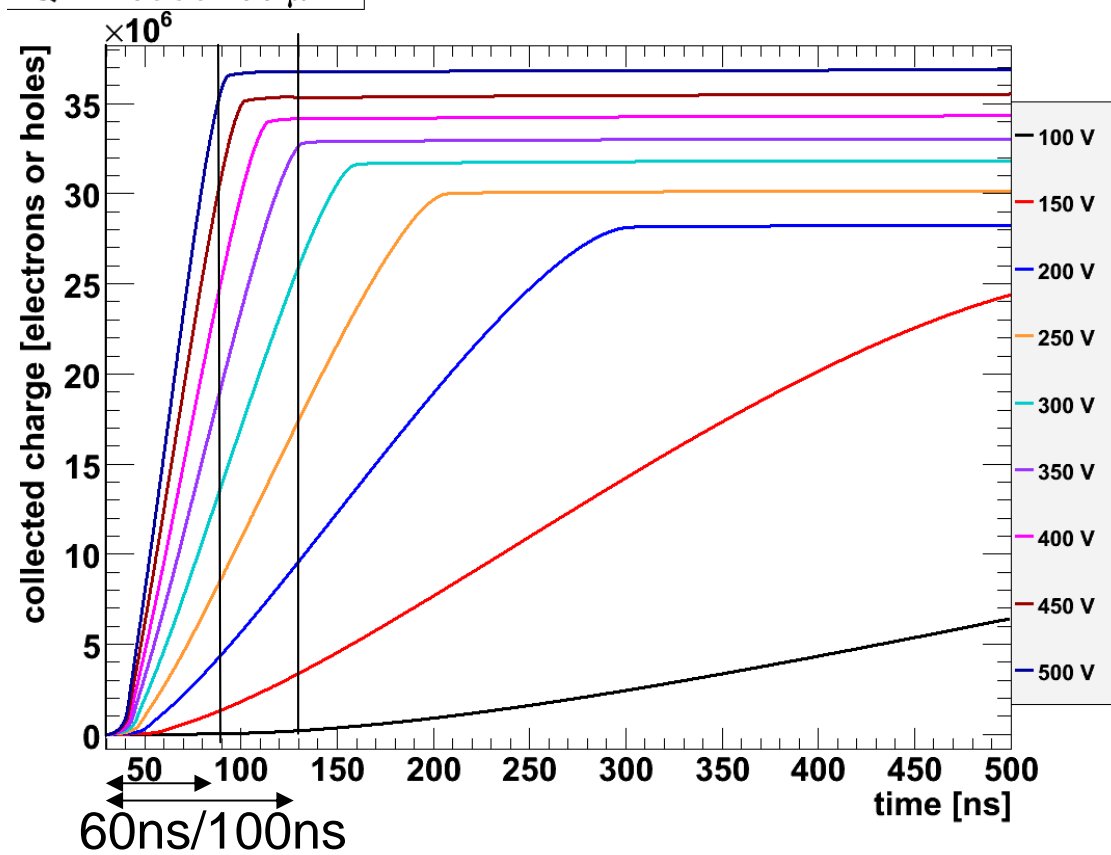
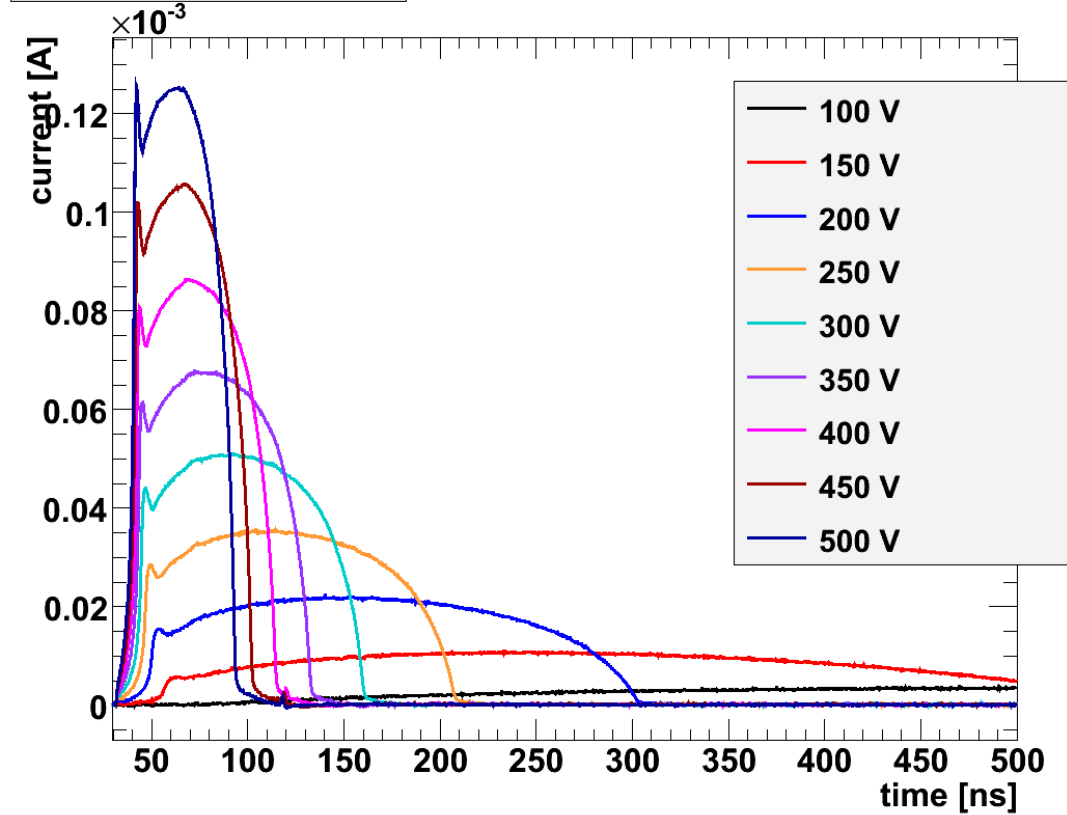
$90 \times 10^6$  e,h pairs  $\rightarrow$   $3.24 \times 10^5$  1 keV photons

current

charge

Transient at 150  $\mu\text{m}$

QT Plot at 150  $\mu\text{m}$



no exponential shape!